

采用 6 引脚 SOT-23 封装的 TPS56120x 4.5V 至 17V 输入、1A 同步降压稳压器

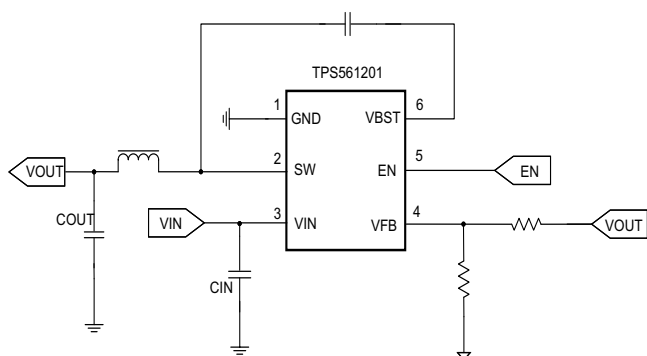
1 特性

- TPS561201 和 TPS561208 1A 转换器集成了 140mΩ 和 84mΩ FET
- D-CAP2™ 模式控制，用于快速瞬态响应
- 输入电压范围：4.5V 至 17V
- 输出电压范围：0.76V 至 7V
- 脉冲跳跃模式 (TPS561201) 或持续电流模式 (TPS561208)
- 580kHz 开关频率
- 低关断电流（小于 10μA）
- 2% 反馈电压精度 (25°C)
- 从预偏置输出电压中启动
- 逐周期过流限制
- 断续模式过流保护
- 非锁存欠压保护 (UVP) 和热关断 (TSD) 保护
- 固定软启动时间：1.0ms
- 使用 TPS56120x 并借助 [WEBENCH® Power Designer](#) 创建定制设计方案

2 应用

- 数字电视电源
- 高清 蓝光™ 光盘播放器
- 网络家庭终端设备
- 数字机顶盒 (STB)
- 安全监控

简化电路原理图



3 说明

TPS561201 和 TPS561208 是采用 SOT-23 封装的简单易用型 1A 同步降压转换器。

此器件被优化为使用尽可能少的外部组件即可运行，并且可以实现低待机电流。

这些开关模式电源 (SMPS) 器件采用 D-CAP2 模式控制，从而提供快速瞬态响应，并且在无需外部补偿组件的情况下支持诸如高分子聚合物等低等效串联电阻 (ESR) 输出电容器以及超低 ESR 陶瓷电容器。

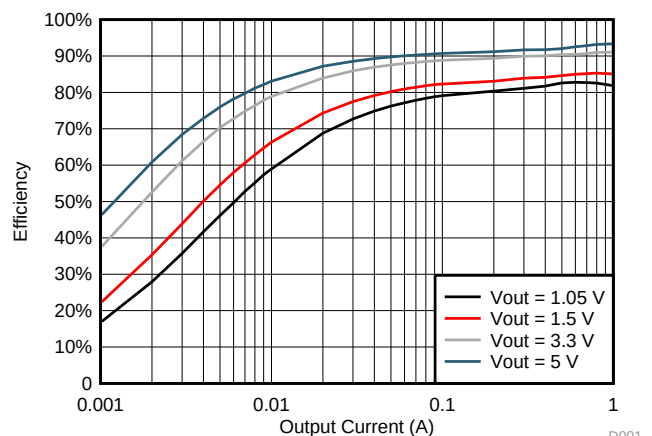
TPS561201 可在脉冲跳跃模式下运行，从而能在轻载运行期间保持高效率。TPS561201 和 TPS561208 可提供 6 引脚 1.6 × 2.9 (mm) SOT (DDC) 封装，额定结温范围为 -40°C 至 125°C。

器件信息⁽¹⁾

器件型号	封装	封装尺寸（标称值）
TPS561201 TPS561208	SOT (6)	1.60mm x 2.90mm

(1) 要了解所有可用封装，请参见数据表末尾的可订购产品附录。

TPS561201 效率



D001



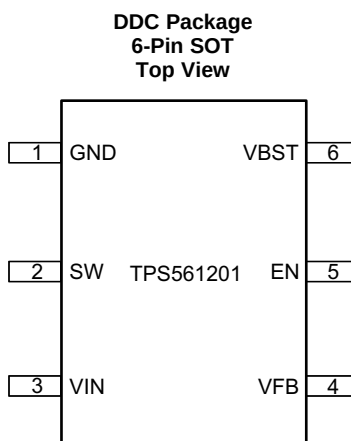
目录

1	特性	1	7.4	Device Functional Modes	11
2	应用	1	8	Application and Implementation	12
3	说明	1	8.1	Application Information	12
4	修订历史记录	2	8.2	Typical Application	12
5	Pin Configuration and Functions	3	9	Power Supply Recommendations	18
6	Specifications	4	10	Layout	18
6.1	Absolute Maximum Ratings	4	10.1	Layout Guidelines	18
6.2	ESD Ratings	4	10.2	Layout Example	18
6.3	Recommended Operating Conditions	4	11	器件和文档支持	19
6.4	Thermal Information	4	11.1	相关链接	19
6.5	Electrical Characteristics	5	11.2	社区资源	19
6.6	Typical Characteristics	6	11.3	商标	19
7	Detailed Description	9	11.4	静电放电警告	19
7.1	Overview	9	11.5	Glossary	19
7.2	Functional Block Diagram	9	12	机械、封装和可订购信息	19
7.3	Feature Description	9			

4 修订历史记录

日期	修订版本	注释
2017 年 4 月	*	首次发布。

5 Pin Configuration and Functions



Pin Functions

PIN		DESCRIPTION
NAME	NO.	
GND	1	Ground pin Source terminal of low-side power NFET as well as the ground terminal for controller circuit. Connect sensitive VFB to this GND at a single point.
SW	2	Switch node connection between high-side NFET and low-side NFET.
VIN	3	Input voltage supply pin. The drain terminal of high-side power NFET.
VFB	4	Converter feedback input. Connect to output voltage with feedback resistor divider.
EN	5	Enable input control. Active high and must be pulled up to enable the device.
VBST	6	Supply input for the high-side NFET gate drive circuit. Connect 0.1- μ F capacitor between VBST and SW pins.

6 Specifications

6.1 Absolute Maximum Ratings

over operating free-air temperature range (unless otherwise noted)⁽¹⁾

		MIN	MAX	UNIT
Input voltage	VIN, EN	−0.3	19	V
	VBST	−0.3	25	V
	VBST (10-ns transient)	−0.3	27	V
	VBST (vs SW)	−0.3	6.5	V
	VFB	−0.3	6.5	V
	SW	−2	19	V
	SW (10 ns transient)	−3.5	21	V
Operating junction temperature, T _J		−40	150	°C
Storage temperature, T _{stg}		−55	150	°C

- (1) Stresses beyond those listed under *Absolute Maximum Ratings* may cause permanent damage to the device. These are stress ratings only, which do not imply functional operation of the device at these or any other conditions beyond those indicated under *Recommended Operating Conditions*. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

6.2 ESD Ratings

		VALUE	UNIT
V _(ESD) Electrostatic discharge	Human-body model (HBM), per ANSI/ESDA/JEDEC JS-001 ⁽¹⁾	±3000	V
	Charged-device model (CDM), per JEDEC specification JESD22-C101 ⁽²⁾	±1500	

- (1) JEDEC document JEP155 states that 500-V HBM allows safe manufacturing with a standard ESD control process.

- (2) JEDEC document JEP157 states that 250-V CDM allows safe manufacturing with a standard ESD control process.

6.3 Recommended Operating Conditions

over operating free-air temperature range (unless otherwise noted)

		MIN	MAX	UNIT
V _{IN}	Supply input voltage	4.5	17	V
V _I	Input voltage	VBST	−0.1	23
		VBST (10-ns transient)	−0.1	26
		VBST(vs SW)	−0.1	6.0
		EN	−0.1	17
		VFB	−0.1	5.5
		SW	−1.8	17
		SW (10 ns transient)	−3.5	20
T _J	Operating junction temperature	−40	125	°C

6.4 Thermal Information

THERMAL METRIC ⁽¹⁾		TPS561201 and TPS561208	UNIT
		DDC (SOT)	
		6 PINS	
R _{θJA}	Junction-to-ambient thermal resistance	90.8	°C/W
R _{θJC(top)}	Junction-to-case (top) thermal resistance	42.3	°C/W
R _{θJB}	Junction-to-board thermal resistance	16.3	°C/W
ψ _{JT}	Junction-to-top characterization parameter	2.6	°C/W
ψ _{JB}	Junction-to-board characterization parameter	16.3	°C/W

- (1) For more information about traditional and new thermal metrics, see the *Semiconductor and IC Package Thermal Metrics* application report, [SPRA953](#).

6.5 Electrical Characteristics

 $T_J = -40^{\circ}\text{C}$ to 125°C , $V = 12\text{ V}$ (unless otherwise noted)

PARAMETER		TEST CONDITIONS		MIN	TYP	MAX	UNIT
SUPPLY CURRENT							
I _{VIN}	Operating – non-switching supply current	V _{IN} current, EN = 5 V, VFB = 0.8 V	TPS561201	380	520	μA	
			TPS561208	590	750		
I _{VINSDN}	Shutdown supply current	V _{IN} current, EN = 0 V		1	10	μA	
LOGIC THRESHOLD							
V _{ENH}	EN high-level input voltage	EN		1.6		V	
V _{ENL}	EN low-level input voltage	EN			0.8	V	
R _{EN}	EN pin resistance to GND	V _{EN} = 12 V		225	400	900	kΩ
VFB VOLTAGE AND DISCHARGE RESISTANCE							
	VFB threshold voltage	V _O = 1.05 V, I _O = 10 mA, Eco-mode™ operation		774		mV	
V _{FBTH}	VFB threshold voltage	V _O = 1.05 V, continuous mode operation	749	768	787	mV	
I _{VFB}	VFB input current	V _{FB} = 0.8 V		0	±0.1	μA	
MOSFET							
R _{DS(on)h}	High-side switch resistance	T _A = 25°C, V _{BST} – SW = 5.5 V		140		mΩ	
R _{DS(on)l}	Low-side switch resistance	T _A = 25°C		84		mΩ	
CURRENT LIMIT							
I _{ocl}	Current limit	DC current, V _{OUT} = 1.05 V, L1 = 2.2 μH	1.2	1.6	2.0	A	
THERMAL SHUTDOWN							
T _{SDN}	Thermal shutdown threshold ⁽¹⁾	Shutdown temperature		160		°C	
		Hysteresis		25			
ON-TIME TIMER CONTROL							
t _{OFF(MIN)}	Minimum off time	VFB = 0.5 V		220	310	ns	
SOFT START							
t _{ss}	Soft-start time	Internal soft-start time		1.0		ms	
Frequency							
F _{sw}	Switching frequency	V _{IN} = 12 V, V _O = 1.05 V, FCCM mode		580		kHz	
OUTPUT UNDERVOLTAGE AND OVERVOLTAGE PROTECTION							
V _{UVP}	Output UVP threshold	Hiccup detect (H > L)		65%			
T _{HICCUP_WAIT}	Hiccup wait time			1.8		ms	
T _{HICCUP_RE}	Hiccup time before restart			15		ms	
UVLO							
UVLO	UVLO threshold	Wake up VIN voltage		4.0	4.3	V	
		Shut down VIN voltage	3.3	3.6			
		Hysteresis VIN voltage		0.4			

(1) Not production tested

6.6 Typical Characteristics

$V_{IN} = 12\text{ V}$ (unless otherwise noted)

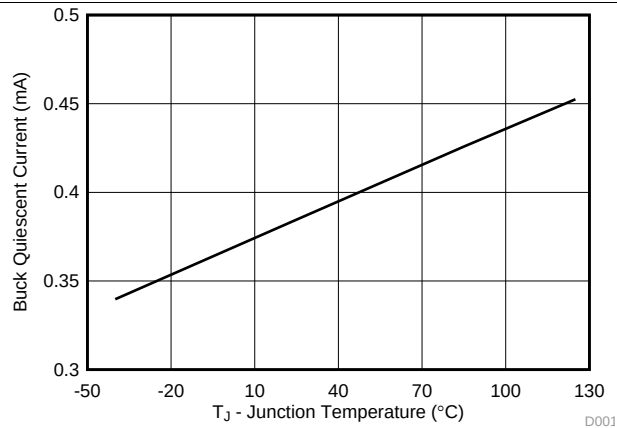


Figure 1. TPS561201 Supply Current vs Junction Temperature

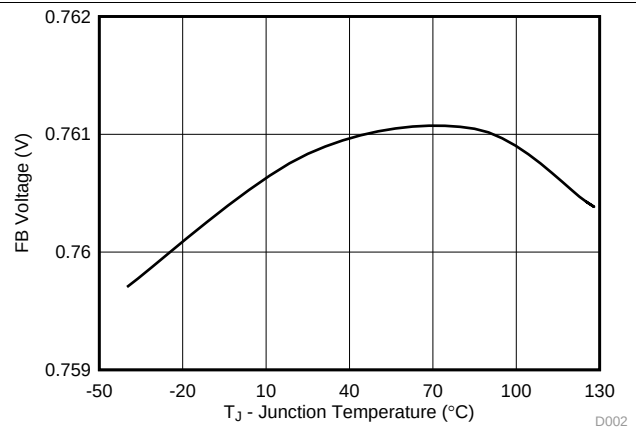


Figure 2. VFB Voltage vs Junction Temperature

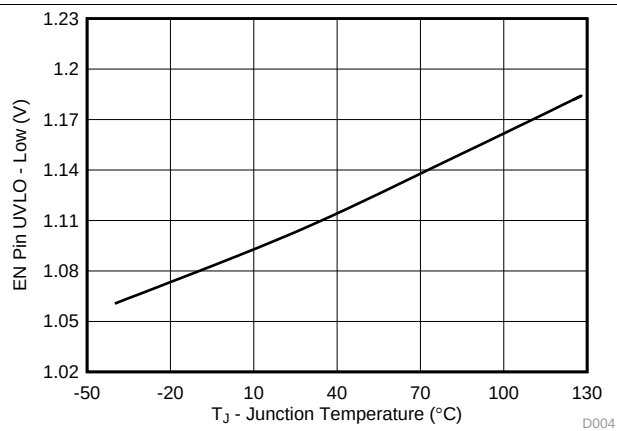


Figure 3. EN Pin UVLO Low Voltage vs Junction Temperature

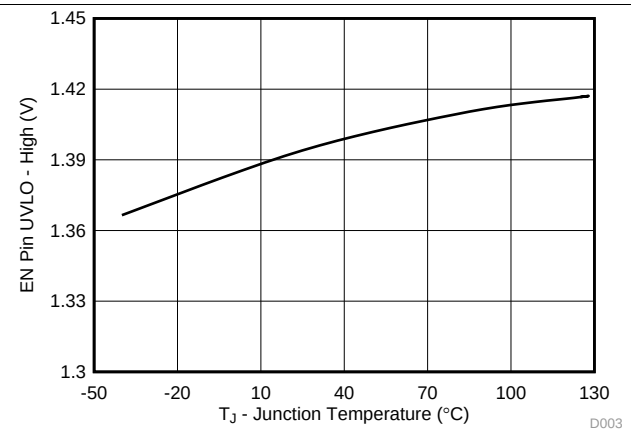


Figure 4. EN Pin UVLO High Voltage vs Junction Temperature

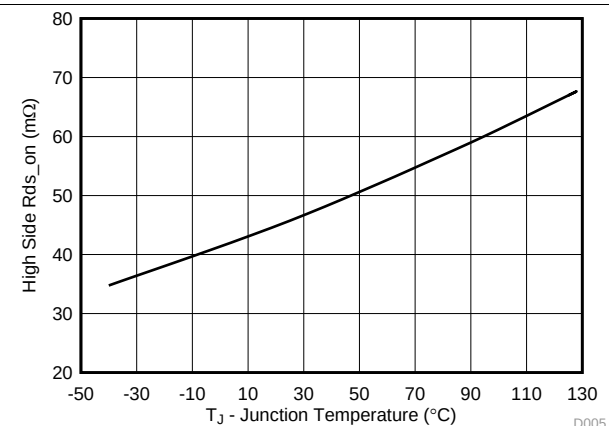


Figure 5. High-Side R_{ds-on} vs Junction Temperature

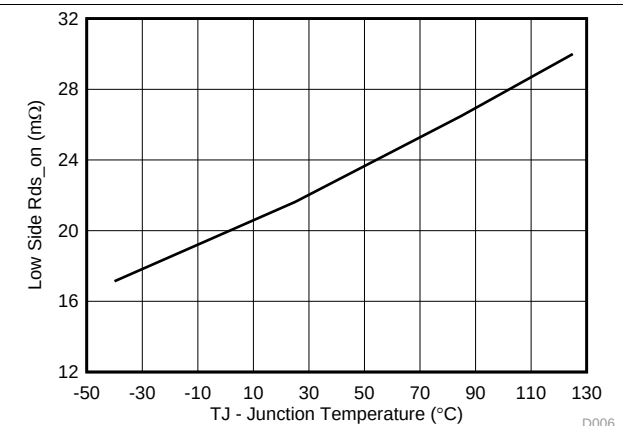


Figure 6. Low-Side R_{ds-on} vs Junction Temperature

Typical Characteristics (continued)

$V_{IN} = 12\text{ V}$ (unless otherwise noted)

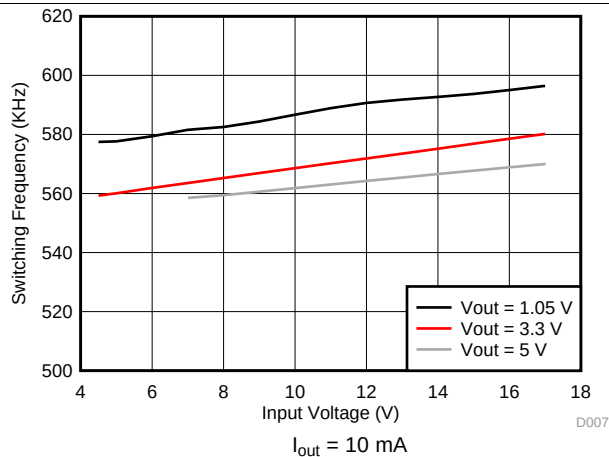


Figure 7. TPS561208 Switching Frequency vs Input Voltage

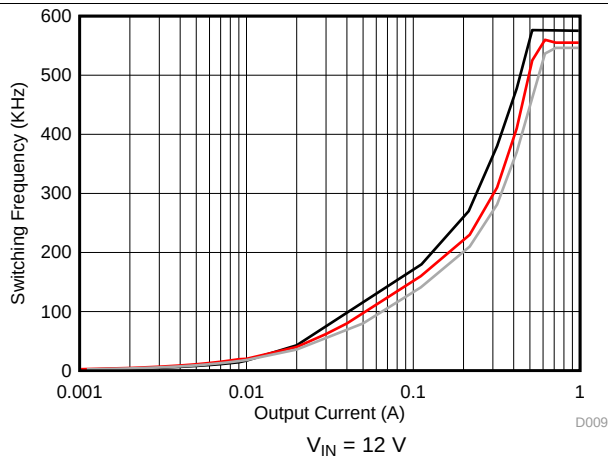


Figure 8. TPS561201 Switching Frequency vs Output Current

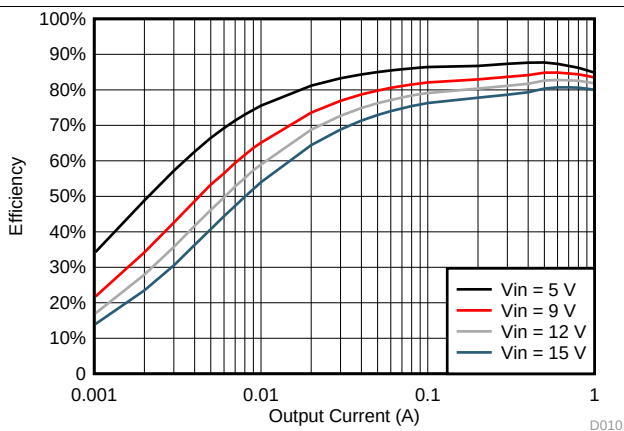


Figure 9. TPS561201 $V_{OUT} = 1.05\text{ V}$ Efficiency, $L = 2.2\text{ }\mu\text{H}$

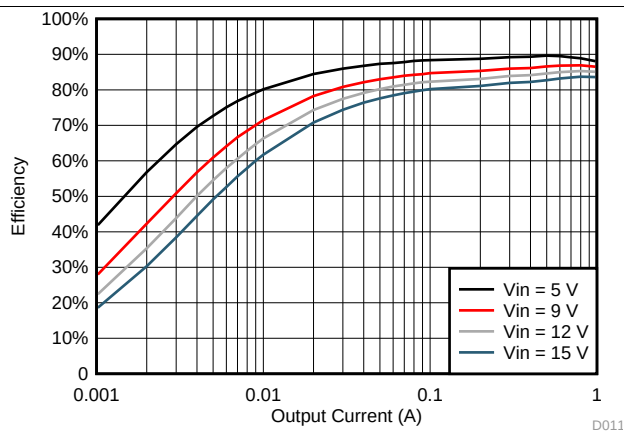


Figure 10. TPS561201 $V_{OUT} = 1.5\text{ V}$ Efficiency, $L = 2.2\text{ }\mu\text{H}$

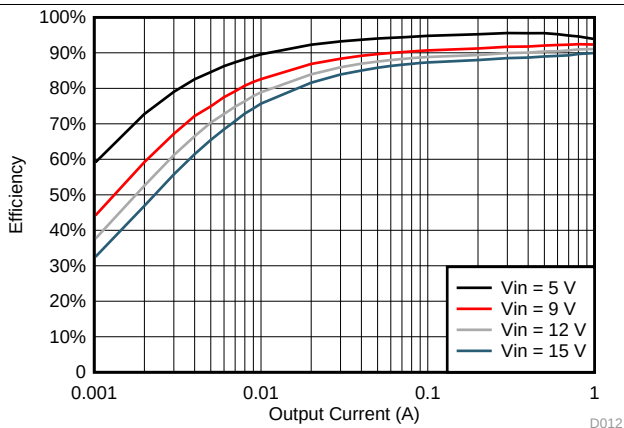


Figure 11. TPS561201 $V_{OUT} = 3.3\text{ V}$ Efficiency, $L = 3.3\text{ }\mu\text{H}$

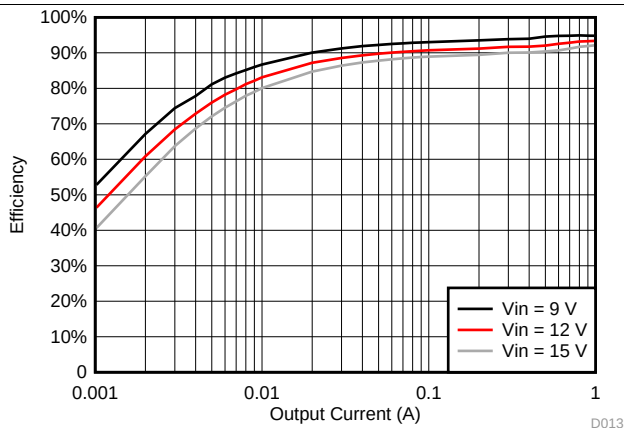


Figure 12. TPS561201 $V_{OUT} = 5\text{ V}$ Efficiency, $L = 4.7\text{ }\mu\text{H}$

Typical Characteristics (continued)

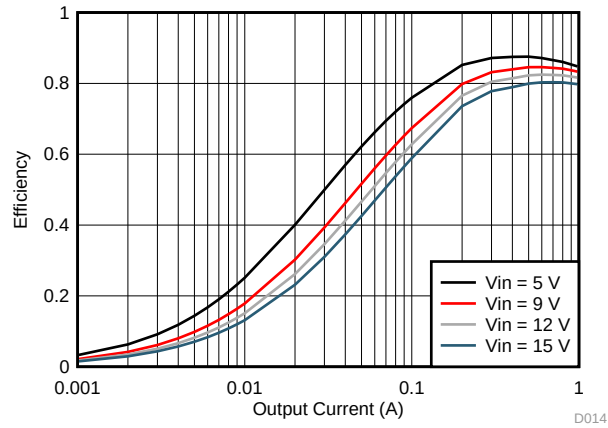
 $V_{IN} = 12\text{ V}$ (unless otherwise noted)


Figure 13. TPS561208 $V_{OUT} = 1.05\text{ V}$ Efficiency, $L = 2.2\text{ }\mu\text{H}$

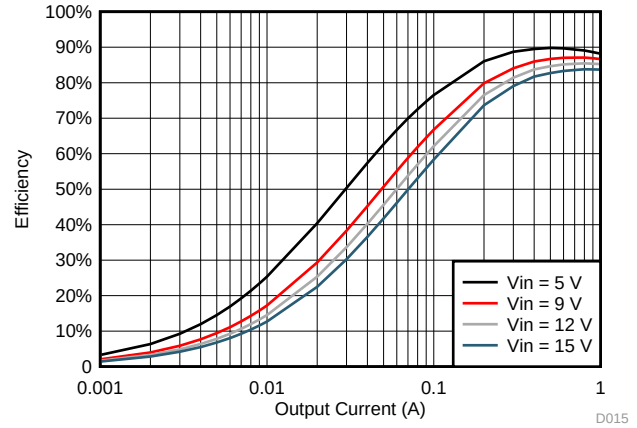


Figure 14. TPS561208 $V_{OUT} = 1.5\text{ V}$ Efficiency, $L = 2.2\text{ }\mu\text{H}$

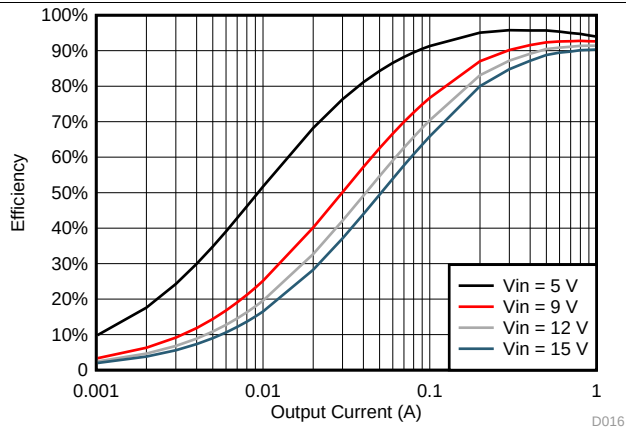


Figure 15. TPS561208 $V_{OUT} = 3.3\text{ V}$ Efficiency, $L = 3.3\text{ }\mu\text{H}$

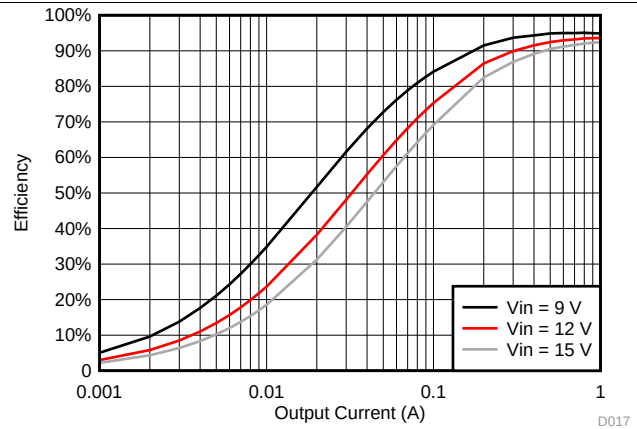


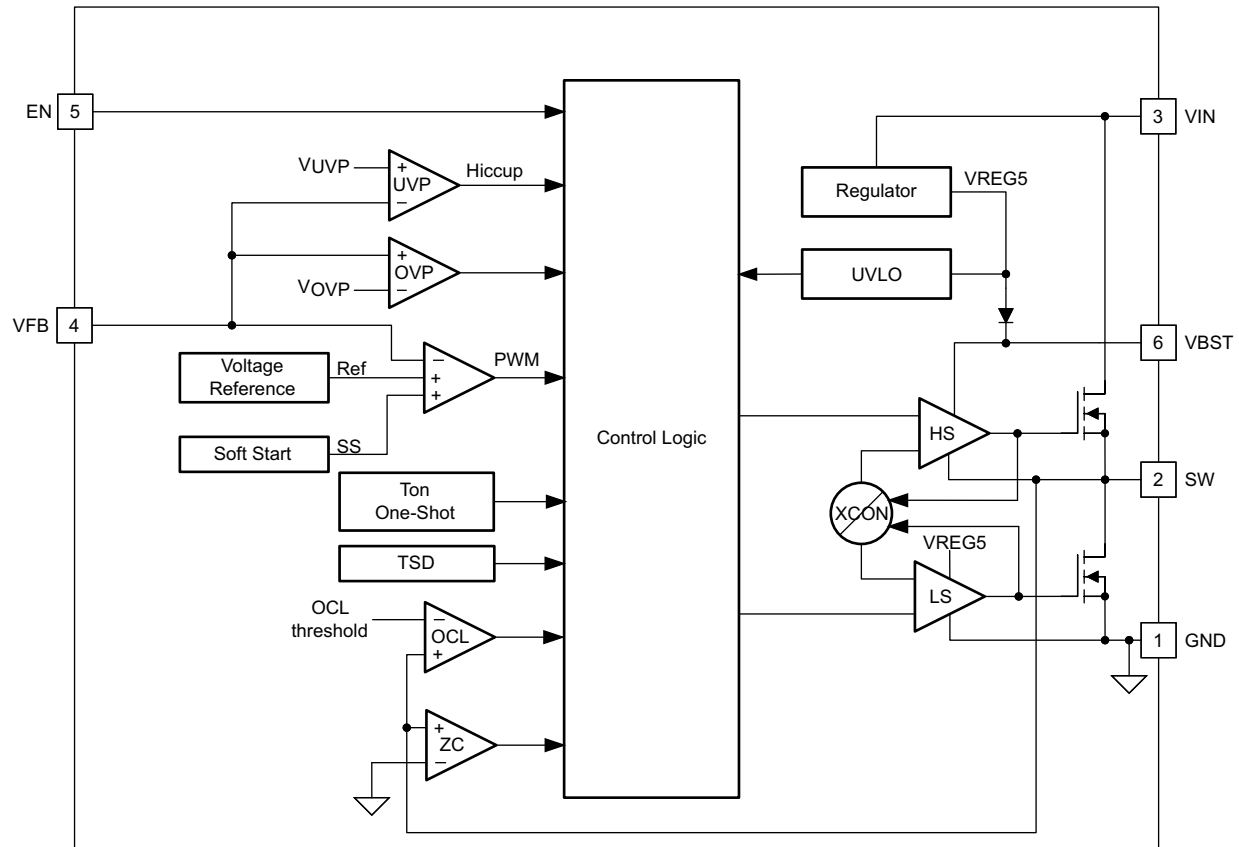
Figure 16. TPS561208 $V_{OUT} = 5\text{ V}$ Efficiency, $L = 4.7\text{ }\mu\text{H}$

7 Detailed Description

7.1 Overview

The TPS561201 and TPS561208 are 1-A synchronous step-down converters. The proprietary D-CAP2 mode control supports low ESR output capacitors such as specialty polymer capacitors and multi-layer ceramic capacitors without complex external compensation circuits. The fast transient response of D-CAP2 mode control can reduce the output capacitance required to meet a specific level of performance.

7.2 Functional Block Diagram



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7.3 Feature Description

7.3.1 Adaptive On-Time Control and PWM Operation

The main control loop of the TPS561201 is adaptive on-time pulse width modulation (PWM) controller that supports a proprietary D-CAP2 mode control. The D-CAP2 mode control combines adaptive on-time control with an internal compensation circuit for pseudo-fixed frequency and low external component count configuration with both low ESR and ceramic output capacitors. It is stable even with virtually no ripple at the output.

At the beginning of each cycle, the high-side MOSFET is turned on. This MOSFET is turned off after internal one shot timer expires. This one shot duration is set proportional to the converter input voltage, V_{IN} , and inversely proportional to the output voltage, V_O , to maintain a pseudo-fixed frequency over the input voltage range, hence it is called adaptive on-time control. The one-shot timer is reset and the high-side MOSFET is turned on again when the feedback voltage falls below the reference voltage. An internal ramp is added to reference voltage to simulate output ripple, eliminating the need for ESR induced output ripple from D-CAP2 mode control.

Feature Description (continued)

7.3.2 Pulse Skip Control (TPS561201)

The TPS561201 and TPS561208 are designed with Advanced Eco-mode to maintain high light load efficiency. As the output current decreases from heavy load condition, the inductor current is also reduced and eventually comes to point that its rippled valley touches zero level, which is the boundary between continuous conduction and discontinuous conduction modes. The rectifying MOSFET is turned off when the zero inductor current is detected. As the load current further decreases the converter runs into discontinuous conduction mode. The on-time is kept almost the same as it was in the continuous conduction mode so that it takes longer time to discharge the output capacitor with smaller load current to the level of the reference voltage. This makes the switching frequency lower, proportional to the load current, and keeps the light load efficiency high. The transition point to the light load operation $I_{OUT(LL)}$ current can be calculated in [Equation 1](#).

$$I_{OUT(LL)} = \frac{1}{2 \times L \times f_{SW}} \times \frac{(V_{IN} - V_{OUT}) \times V_{OUT}}{V_{IN}} \quad (1)$$

7.3.3 Soft Start and Pre-Biased Soft Start

The TPS561201 and TPS561208 have an internal 1.0-ms soft-start. When the EN pin becomes high, the internal soft-start function begins ramping up the reference voltage to the PWM comparator. If the output capacitor is pre-biased at startup, the devices initiate switching and start ramping up only after the internal reference voltage becomes greater than the feedback voltage VFB. This scheme ensures that the converters ramp up smoothly into regulation point.

7.3.4 Current Protection

The output over-current limit (OCL) is implemented using a cycle-by-cycle valley detect control circuit. The switch current is monitored during the OFF state by measuring the low-side FET drain to source voltage. This voltage is proportional to the switch current. To improve accuracy, the voltage sensing is temperature compensated.

During the on time of the high-side FET switch, the switch current increases at a linear rate determined by V_{in} , V_{out} , the on-time and the output inductor value. During the on time of the low-side FET switch, this current decreases linearly. The average value of the switch current is the load current I_{out} . If the monitored current is above the OCL level, the converter maintains low-side FET on and delays the creation of a new set pulse, even the voltage feedback loop requires one, until the current level becomes OCL level or lower. In subsequent switching cycles, the on-time is set to a fixed value and the current is monitored in the same manner.

There are some important considerations for this type of over-current protection. The load current is higher than the overcurrent threshold by one half of the peak-to-peak inductor ripple current. Also, when the current is being limited, the output voltage tends to fall as the demanded load current may be higher than the current available from the converter. This may cause the output voltage to fall. When the VFB voltage falls below the UVP threshold voltage, the UVP comparator detects it. And then, the device will shut down after the UVP delay time (typically 24 μ s) and restart after the hiccup time (typically 15 ms).

When the over current condition is removed, the output voltage returns to the regulated value.

7.3.5 Undervoltage Lockout (UVLO) Protection

UVLO protection monitors the internal regulator voltage. When the voltage is lower than UVLO threshold voltage, the device is shut off. This protection is non-latching.

7.3.6 Thermal Shutdown

The device monitors the temperature of itself. If the temperature exceeds the threshold value (typically 160°C), the device is shut off. This is a non-latch protection.

7.4 Device Functional Modes

7.4.1 Normal Operation

When the input voltage is above the UVLO threshold and the EN voltage is above the enable threshold, the TPS561208 can operate in their normal switching modes. Normal continuous conduction mode (CCM) occurs when the minimum switch current is above 0 A. In CCM, the TPS561208 operates at a quasi-fixed frequency of 580 kHz.

7.4.2 Eco-mode Operation

When the TPS561201 and TPS561208 are in the normal CCM operating mode and the switch current falls to 0 A, the TPS561201 begins operating in pulse skipping Eco-mode. Each switching cycle is followed by a period of energy saving sleep time. The sleep time ends when the VFB voltage falls below the Eco-mode threshold voltage. As the output current decreases, the perceived time between switching pulses increases.

7.4.3 Standby Operation

When the TPS561201 and TPS561208 are operating in either normal CCM or Eco-mode, they may be placed in standby by asserting the EN pin low.

8 Application and Implementation

NOTE

Information in the following applications sections is not part of the TI component specification, and TI does not warrant its accuracy or completeness. TI's customers are responsible for determining suitability of components for their purposes. Customers should validate and test their design implementation to confirm system functionality.

8.1 Application Information

The devices are typical step-down DC-DC converters. It typically uses to convert a higher dc voltage to a lower dc voltage with a maximum available output current of 1 A. The following design procedure can be used to select component values for the TPS561201 and TPS561208. Alternately, the WEBENCH® software may be used to generate a complete design. The WEBENCH software uses an iterative design procedure and accesses a comprehensive database of components when generating a design. This section presents a simplified discussion of the design process.

8.2 Typical Application

The application schematic in Figure 17 was developed to meet the previous requirements. This circuit is available as the evaluation module (EVM). The sections provide the design procedure.

Figure 17 shows the TPS561201 and TPS561208 4.5-V to 17-V Input, 1.05-V output converter schematics.

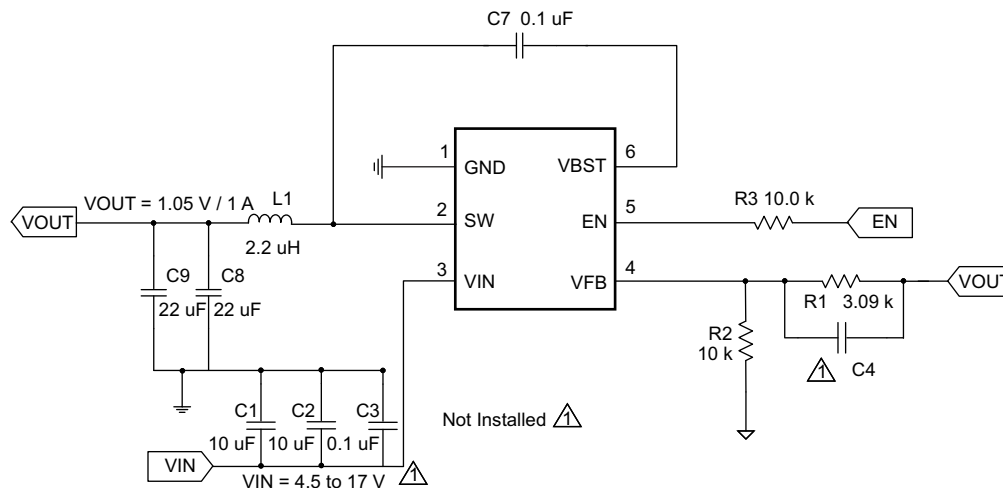


Figure 17. TPS561201 and TPS561208 1.05-V/1-A Reference Design

8.2.1 Design Requirements

Table 1 shows the design parameters.

Table 1. Design Parameters

PARAMETER	EXAMPLE VALUE
Input voltage range	4.5 to 17 V
Output voltage	1.05 V
Transient response, 1-A load step	$\Delta V_{out} = \pm 5\%$
Input ripple voltage	400 mV
Output ripple voltage	30 mV
Output current rating	1A
Operating frequency	580 kHz

8.2.2 Detailed Design Procedure

8.2.2.1 Custom Design With WEBENCH® Tools

[Click here](#) to create a custom design using the TPS56120x device with the WEBENCH® Power Designer.

1. Start by entering the input voltage (V_{IN}), output voltage (V_{OUT}), and output current (I_{OUT}) requirements.
2. Optimize the design for key parameters such as efficiency, footprint, and cost using the optimizer dial.
3. Compare the generated design with other possible solutions from Texas Instruments.

The WEBENCH Power Designer provides a customized schematic along with a list of materials with real-time pricing and component availability.

In most cases, these actions are available:

- Run electrical simulations to see important waveforms and circuit performance
- Run thermal simulations to understand board thermal performance
- Export customized schematic and layout into popular CAD formats
- Print PDF reports for the design, and share the design with colleagues

Get more information about WEBENCH tools at www.ti.com/WEBENCH.

8.2.2.2 Output Voltage Resistors Selection

The output voltage is set with a resistor divider from the output node to the VFB pin. TI recommends to use 1% tolerance or better divider resistors. Start by using [Equation 2](#) to calculate V_{OUT} .

To improve efficiency at very light loads consider using larger value resistors, too high of resistance will be more susceptible to noise and voltage errors from the VFB input current will be more noticeable.

$$V_{OUT} = 0.768 \times \left(1 + \frac{R1}{R2} \right) \quad (2)$$

8.2.2.3 Output Filter Selection

The LC filter used as the output filter has double pole at:

$$F_P = \frac{1}{2\pi\sqrt{L_{OUT} \times C_{OUT}}} \quad (3)$$

At low frequencies, the overall loop gain is set by the output set-point resistor divider network and the internal gain of the device. The low frequency phase is 180 degrees. At the output filter pole frequency, the gain rolls off at a –40 dB per decade rate and the phase drops rapidly. D-CAP2 introduces a high frequency zero that reduces the gain roll off to –20 dB per decade and increases the phase to 90 degrees one decade above the zero frequency. The inductor and capacitor for the output filter must be selected so that the double pole of Equation 3 is located below the high frequency zero but close enough that the phase boost provided by the high frequency zero provides adequate phase margin for a stable circuit. To meet this requirement use the values recommended in [Table 2](#).

Table 2. Recommended Component Values

OUTPUT VOLTAGE (V)	R1 (kΩ)	R2 (kΩ)	L1 (μH)			C8 + C9 (μF)
			MIN	TYP	MAX	
1	3.09	10.0	2.2	2.2	4.7	20 to 68
1.05	3.74	10.0	2.2	2.2	4.7	20 to 68
1.2	5.76	10.0	2.2	2.2	4.7	20 to 68
1.5	9.53	10.0	2.2	2.2	4.7	20 to 68
1.8	13.7	10.0	2.2	2.2	4.7	20 to 68
2.5	22.6	10.0	3.3	3.3	4.7	20 to 68
3.3	33.2	10.0	3.3	3.3	4.7	20 to 68
5	54.9	10.0	3.3	4.7	4.7	20 to 68
6.5	75	10.0	3.3	4.7	4.7	20 to 68

The inductor peak-to-peak ripple current, peak current and RMS current are calculated using [Equation 4](#), [Equation 5](#), and [Equation 6](#). The inductor saturation current rating must be greater than the calculated peak current and the RMS or heating current rating must be greater than the calculated RMS current.

Use 580 kHz for f_{SW} . Make sure the chosen inductor is rated for the peak current of [Equation 5](#) and the RMS current of [Equation 6](#).

$$I_{P-P} = \frac{V_{OUT}}{V_{IN(MAX)}} \times \frac{V_{IN(MAX)} - V_{OUT}}{L_O \times f_{SW}} \quad (4)$$

$$I_{PEAK} = I_O + \frac{I_{P-P}}{2} \quad (5)$$

$$I_{LO(RMS)} = \sqrt{I_O^2 + \frac{1}{12} I_{P-P}^2} \quad (6)$$

For this design example, the calculated peak current is 1.69 A and the calculated RMS current is 1.11 A. The inductor used is a WE 744311330 with a peak current rating of 11 A and an RMS current rating of 6.5 A.

The capacitor value and ESR determines the amount of output voltage ripple. The TPS561201 and TPS561208 are intended for use with ceramic or other low-ESR capacitors. Recommended values range from 20 μ F to 68 μ F. Use [Equation 7](#) to determine the required RMS current rating for the output capacitor.

$$I_{CO(RMS)} = \frac{V_{OUT} \times (V_{IN} - V_{OUT})}{\sqrt{12} \times V_{IN} \times L_O \times f_{SW}} \quad (7)$$

For this design two TDK C3216X5R0J226M 22- μ F output capacitors are used. The typical ESR is 2 m Ω each. The calculated RMS current is 0.286 A.

8.2.2.4 Input Capacitor Selection

The TPS561201 and TPS561208 require an input decoupling capacitor and a bulk capacitor is needed depending on the application. TI recommends a ceramic capacitor over 10 μ F for the decoupling capacitor. An additional 0.1- μ F capacitor (C3) from pin 3 to ground is optional to provide additional high frequency filtering. The capacitor voltage rating needs to be greater than the maximum input voltage.

8.2.2.5 Bootstrap Capacitor Selection

A 0.1- μ F ceramic capacitor must be connected between the VBST to SW pin for proper operation. TI recommends to use a ceramic capacitor.

8.2.3 Application Curves

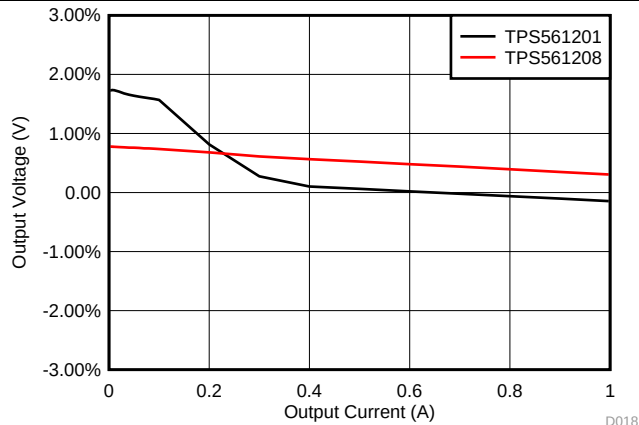


Figure 18. Load Regulation $V_{IN} = 5\text{ V}$

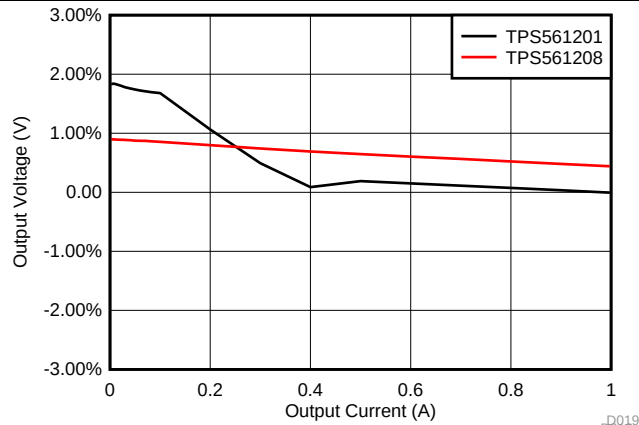


Figure 19. Load Regulation $V_{IN} = 12\text{ V}$

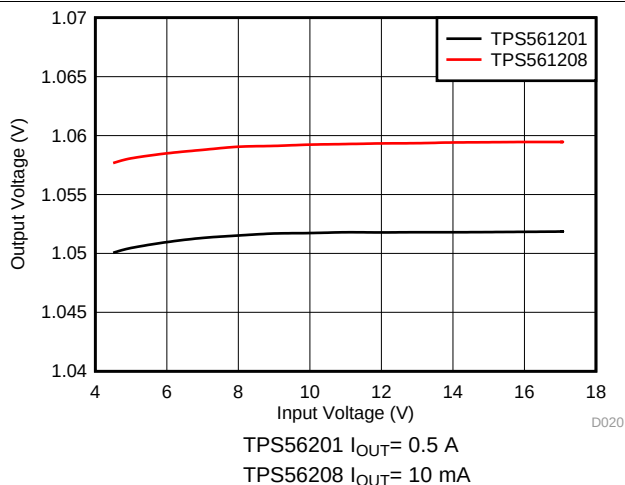


Figure 20. Line Regulation

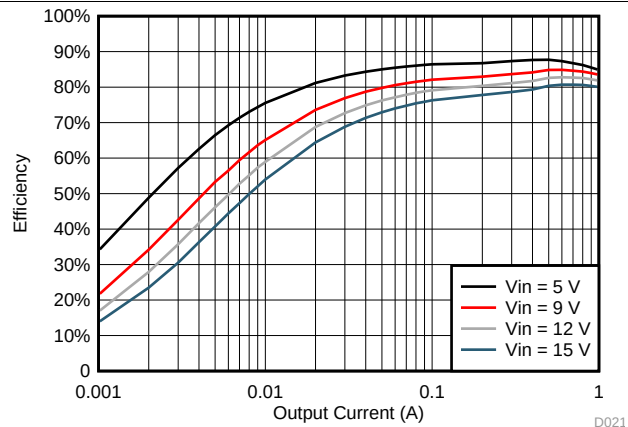


Figure 21. TPS561201 $V_{OUT} = 1.05\text{ V}$, Efficiency $L = 2.2\text{ }\mu\text{H}$

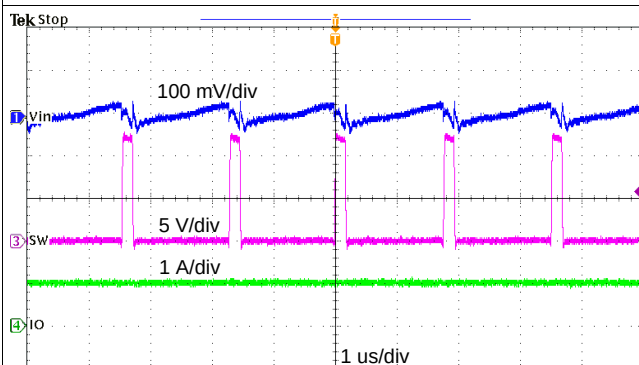


Figure 22. TPS561201 Input Voltage Ripple

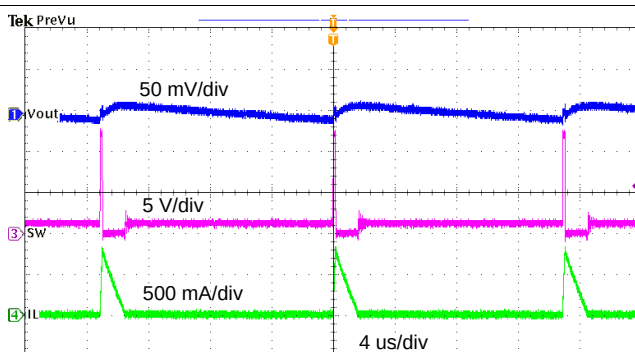


Figure 23. TPS561201 Output Voltage Ripple, $I_{OUT} = 10\text{ mA}$

TPS561201, TPS561208

ZHCSG73 – APRIL 2017

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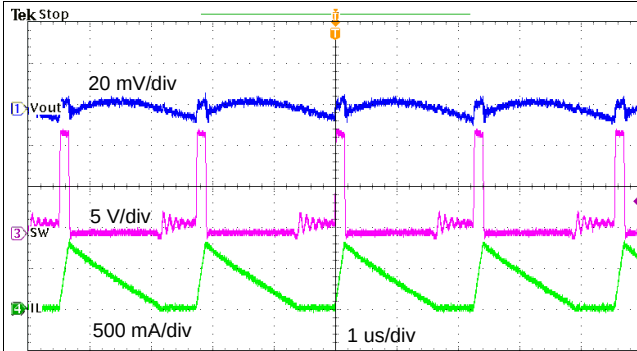


Figure 24. TPS561201 Output Voltage Ripple, $I_{OUT} = 0.25\text{ A}$

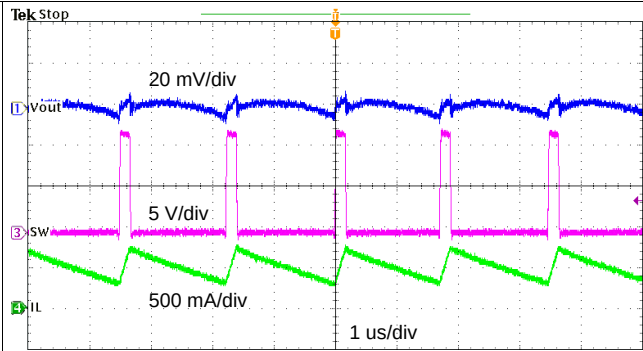


Figure 25. TPS561201 Output Voltage Ripple, $I_{OUT} = 1\text{ A}$

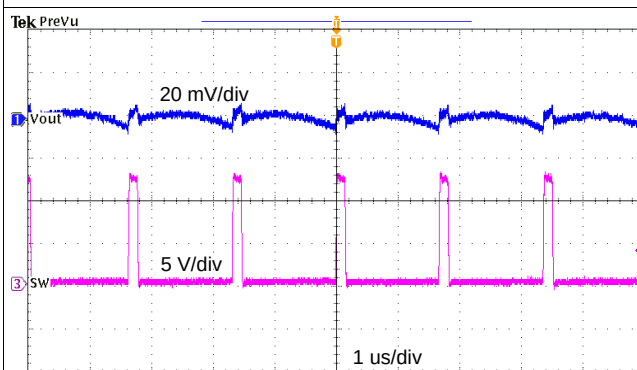


Figure 26. TPS561208 Output Voltage Ripple, $I_{OUT} = 0\text{ A}$

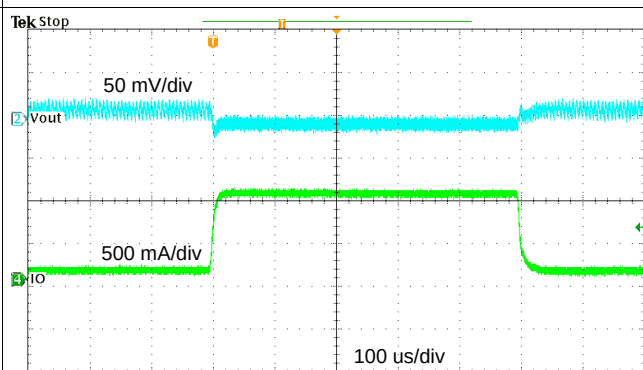


Figure 27. TPS561201 Transient Response, 0.1 to 1 A

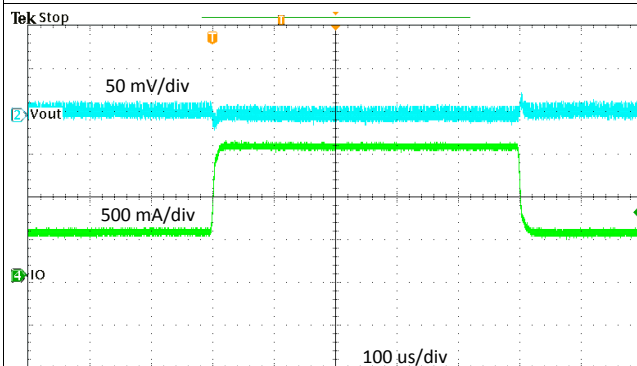


Figure 28. TPS561201 Transient Response, 0.5 to 1.5 A

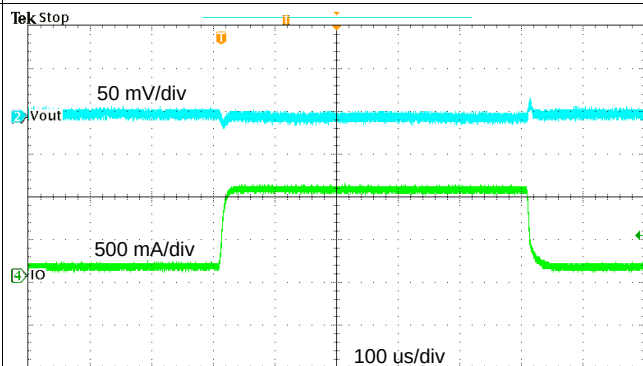


Figure 29. TPS561208 Transient Response 0.1 to 1 A

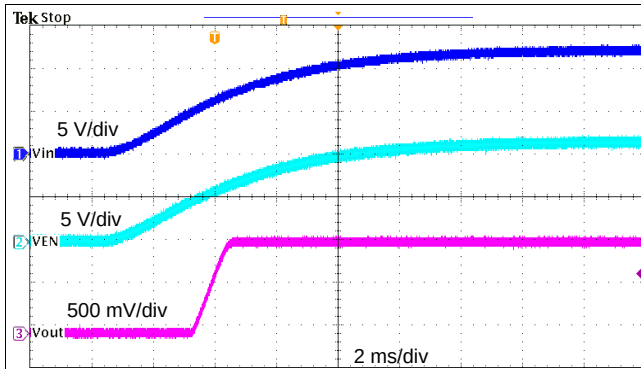


Figure 30. TPS561201 Start-Up Relative to V_I

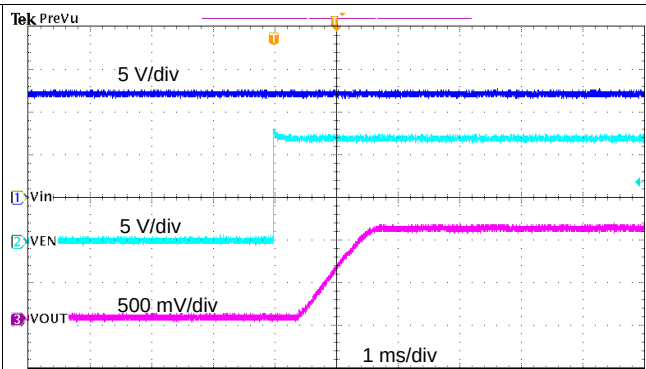


Figure 31. TPS561201 Start-Up Relative to EN

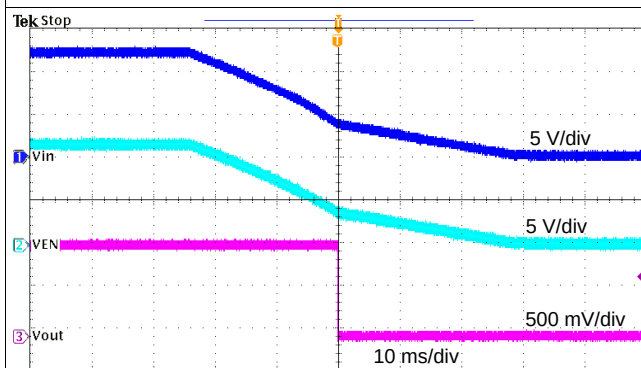


Figure 32. TPS561201 Shutdown Relative to V_I

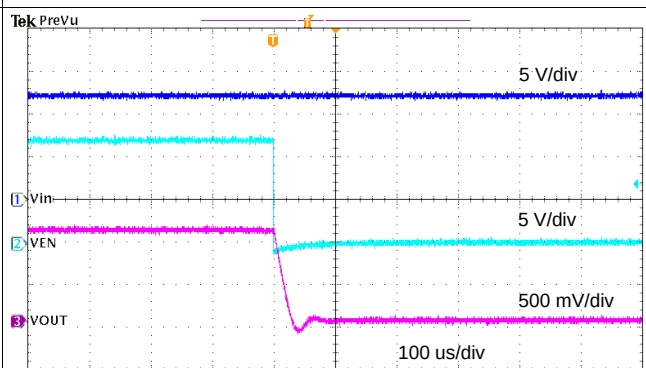


Figure 33. TPS561201 Shutdown Relative to EN

9 Power Supply Recommendations

The TPS561201 and TPS561208 are designed to operate from input supply voltage in the range of 4.5 V to 17 V. Buck converters require the input voltage to be higher than the output voltage for proper operation. The maximum recommended operating duty cycle is 75%. Using that criteria, the minimum recommended input voltage is $V_O / 0.75$.

10 Layout

10.1 Layout Guidelines

1. VIN and GND traces should be as wide as possible to reduce trace impedance. The wide areas are also of advantage from the view point of heat dissipation.
2. The input capacitor and output capacitor should be placed as close to the device as possible to minimize trace impedance.
3. Provide sufficient vias for the input capacitor and output capacitor.
4. Keep the SW trace as physically short and wide as practical to minimize radiated emissions.
5. Do not allow switching current to flow under the device.
6. A separate VOUT path should be connected to the upper feedback resistor.
7. Make a Kelvin connection to the GND pin for the feedback path.
8. Voltage feedback loop should be placed away from the high-voltage switching trace, and preferably has ground shield.
9. The trace of the VFB node should be as small as possible to avoid noise coupling.
10. The GND trace between the output capacitor and the GND pin should be as wide as possible to minimize its trace impedance.

10.2 Layout Example

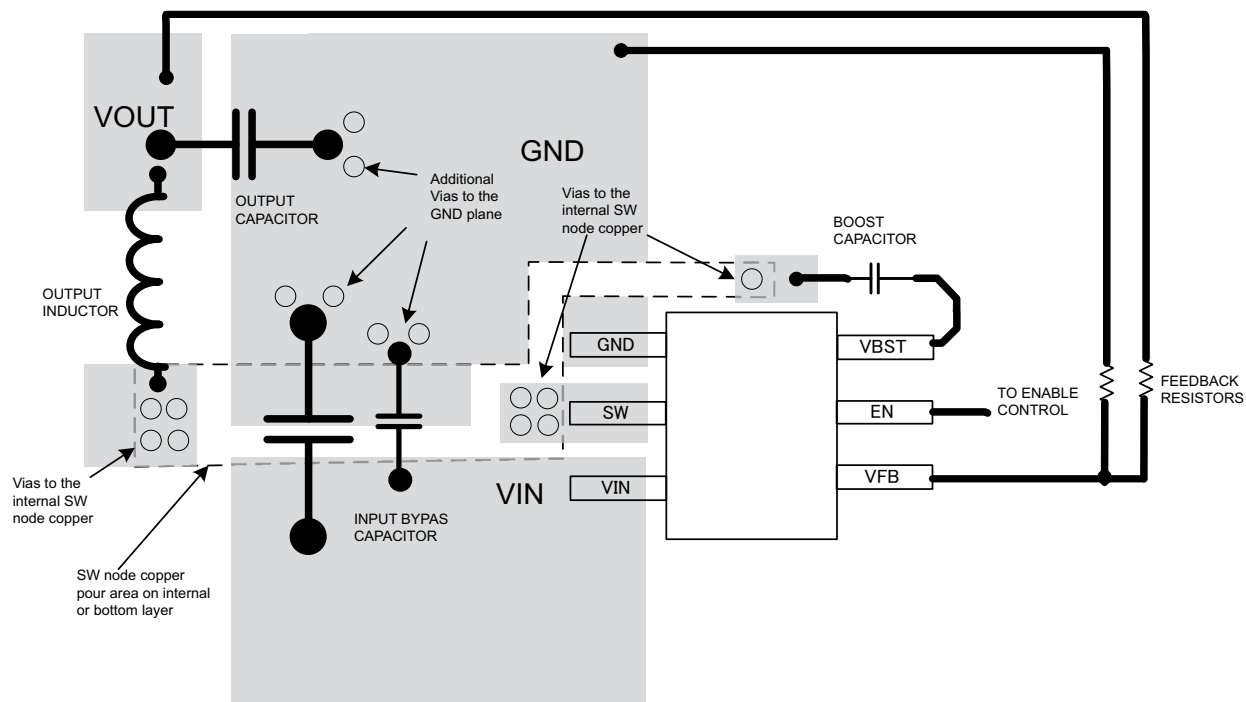


Figure 34. TPS561201 and TPS561208 Layout

11 器件和文档支持

11.1 相关链接

下面的表格列出了快速访问链接。范围包括技术文档、支持与社区资源、工具和软件，并且可通过快速访问立刻订购。

表 3. 相关链接

器件	产品文件夹	立即订购	技术文档	工具与软件	支持与社区
TPS561201	请单击此处	请单击此处	请单击此处	请单击此处	请单击此处
TPS561208	请单击此处	请单击此处	请单击此处	请单击此处	请单击此处

11.2 社区资源

The following links connect to TI community resources. Linked contents are provided "AS IS" by the respective contributors. They do not constitute TI specifications and do not necessarily reflect TI's views; see TI's [Terms of Use](#).

TI E2E™ Online Community *TI's Engineer-to-Engineer (E2E) Community*. Created to foster collaboration among engineers. At e2e.ti.com, you can ask questions, share knowledge, explore ideas and help solve problems with fellow engineers.

Design Support *TI's Design Support* Quickly find helpful E2E forums along with design support tools and contact information for technical support.

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11.5 Glossary

[SLYZ022](#) — *TI Glossary*.

This glossary lists and explains terms, acronyms, and definitions.

12 机械、封装和可订购信息

以下页中包括机械封装和可订购信息。这些信息是针对指定器件可提供的最新数据。这些数据会在无通知且不对本文档进行修订的情况下发生改变。欲获得该数据表的浏览器版本，请查阅左侧的导航栏。

PACKAGING INFORMATION

Orderable Device	Status (1)	Package Type	Package Drawing	Pins	Package Qty	Eco Plan (2)	Lead/Ball Finish (6)	MSL Peak Temp (3)	Op Temp (°C)	Device Marking (4/5)	Samples
TPS561201DDCR	ACTIVE	SOT-23-THIN	DDC	6	3000	Green (RoHS & no Sb/Br)	CU SN	Level-1-260C-UNLIM	-40 to 85	1201	Samples
TPS561201DDCT	ACTIVE	SOT-23-THIN	DDC	6	250	Green (RoHS & no Sb/Br)	CU SN	Level-1-260C-UNLIM	-40 to 85	1201	Samples
TPS561208DDCR	ACTIVE	SOT-23-THIN	DDC	6	3000	Green (RoHS & no Sb/Br)	CU SN	Level-1-260C-UNLIM	-40 to 85	1208	Samples
TPS561208DDCT	ACTIVE	SOT-23-THIN	DDC	6	250	Green (RoHS & no Sb/Br)	CU SN	Level-1-260C-UNLIM	-40 to 85	1208	Samples

(1) The marketing status values are defined as follows:

ACTIVE: Product device recommended for new designs.

LIFEBUY: TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.

NRND: Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.

PREVIEW: Device has been announced but is not in production. Samples may or may not be available.

OBSOLETE: TI has discontinued the production of the device.

(2) **RoHS:** TI defines "RoHS" to mean semiconductor products that are compliant with the current EU RoHS requirements for all 10 RoHS substances, including the requirement that RoHS substance do not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, "RoHS" products are suitable for use in specified lead-free processes. TI may reference these types of products as "Pb-Free".

RoHS Exempt: TI defines "RoHS Exempt" to mean products that contain lead but are compliant with EU RoHS pursuant to a specific EU RoHS exemption.

Green: TI defines "Green" to mean the content of Chlorine (Cl) and Bromine (Br) based flame retardants meet JS709B low halogen requirements of <=1000ppm threshold. Antimony trioxide based flame retardants must also meet the <=1000ppm threshold requirement.

(3) MSL, Peak Temp. - The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.

(4) There may be additional marking, which relates to the logo, the lot trace code information, or the environmental category on the device.

(5) Multiple Device Markings will be inside parentheses. Only one Device Marking contained in parentheses and separated by a "-" will appear on a device. If a line is indented then it is a continuation of the previous line and the two combined represent the entire Device Marking for that device.

(6) Lead/Ball Finish - Orderable Devices may have multiple material finish options. Finish options are separated by a vertical ruled line. Lead/Ball Finish values may wrap to two lines if the finish value exceeds the maximum column width.

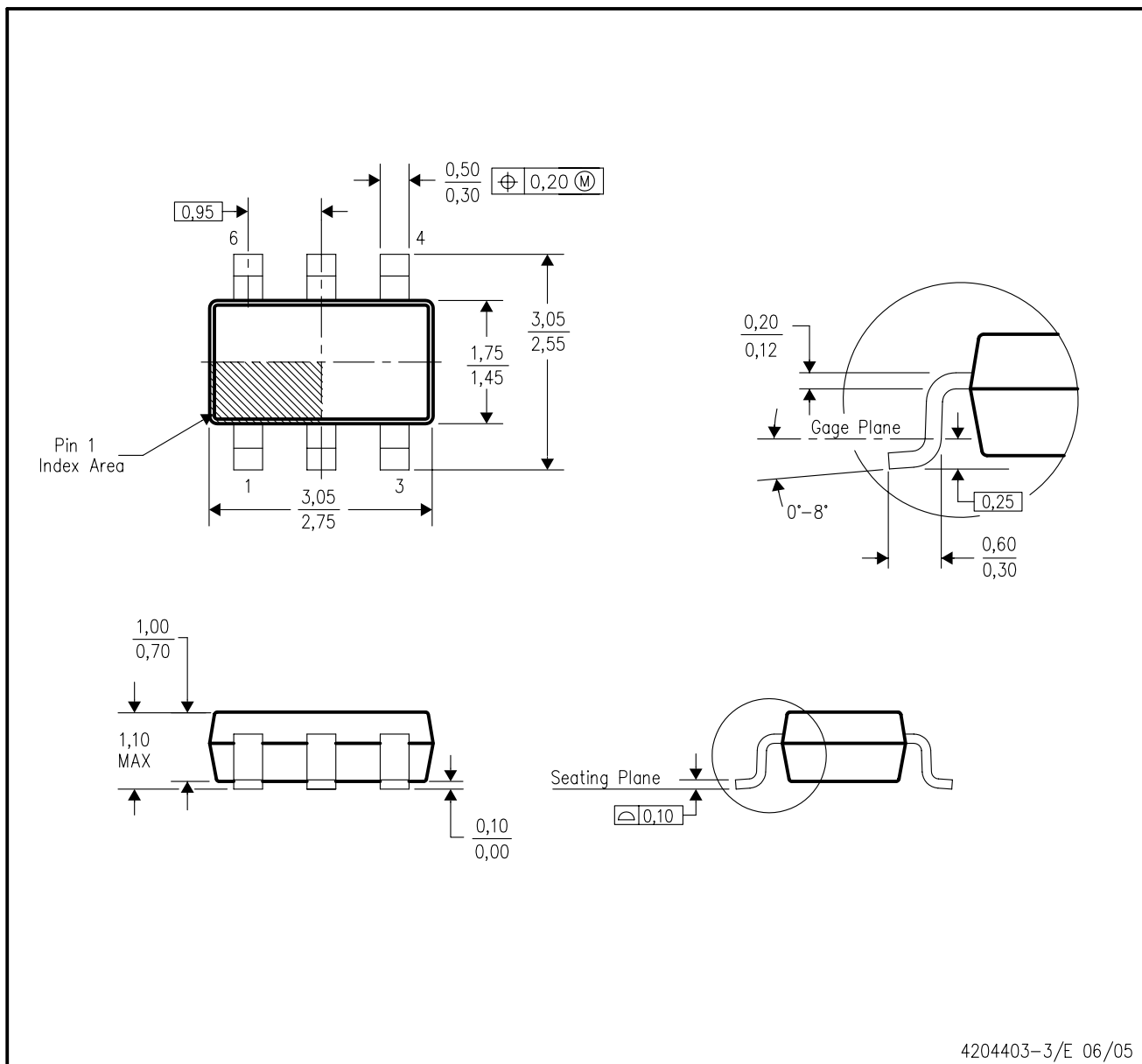
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PLASTIC SMALL-OUTLINE



- NOTES:
- A. All linear dimensions are in millimeters.
 - B. This drawing is subject to change without notice.
 - C. Body dimensions do not include mold flash or protrusion.
 - D. Falls within JEDEC MO-193 variation AA (6 pin).

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